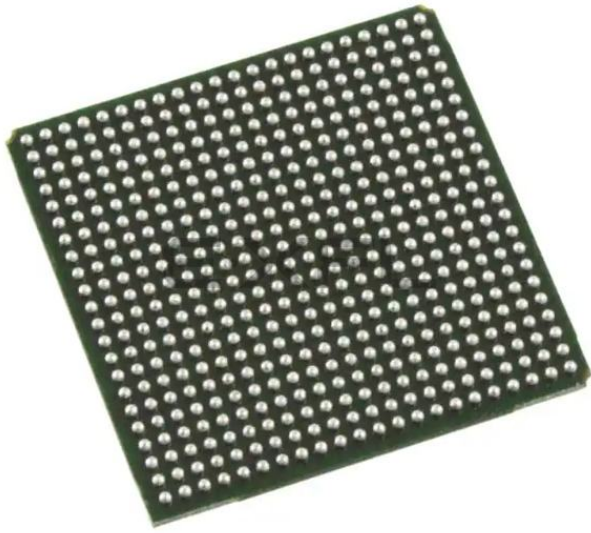




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

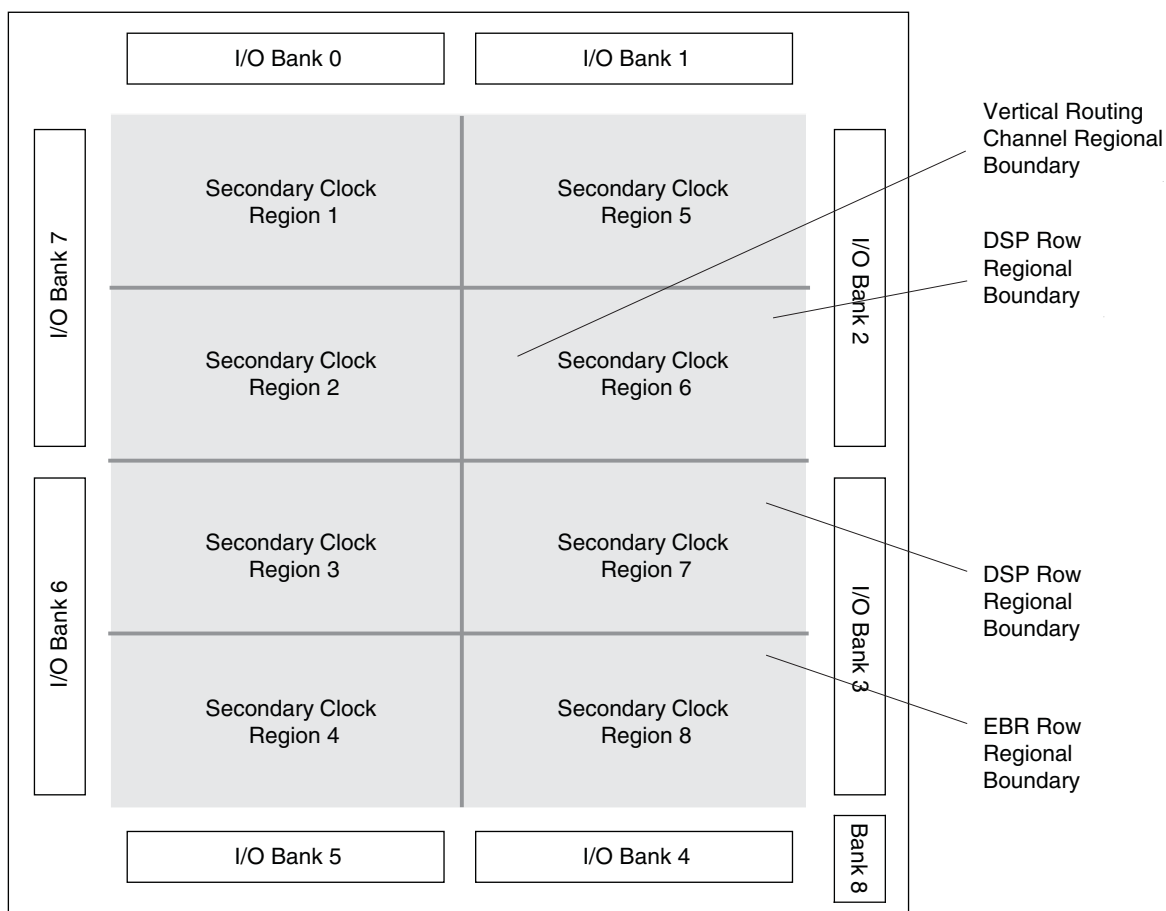
Details

Product Status	Active
Number of LABs/CLBs	2625
Number of Logic Elements/Cells	21000
Total RAM Bits	282624
Number of I/O	331
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-20se-5fn484i

this special vertical routing channel and the eight secondary clock regions for the ECP2-50. LatticeECP2 devices have four secondary clocks (SC0 to SC3) which are distributed to every region.

The secondary clock muxes are located in the center of the device. Figure 2-16 shows the mux structure of the secondary clock routing. Secondary clocks SC0 to SC3 are used for clock and control and SC4 to SC7 are used for high fan-out signals.

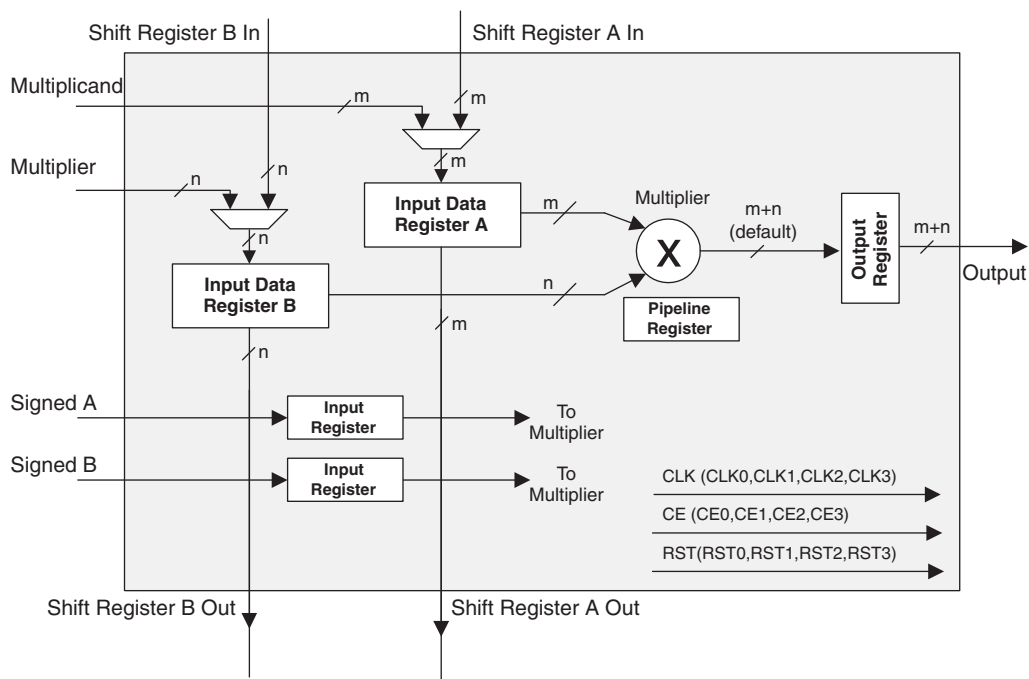
Figure 2-15. Secondary Clock Regions ECP2-50



MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-23 shows the MULT sysDSP element.

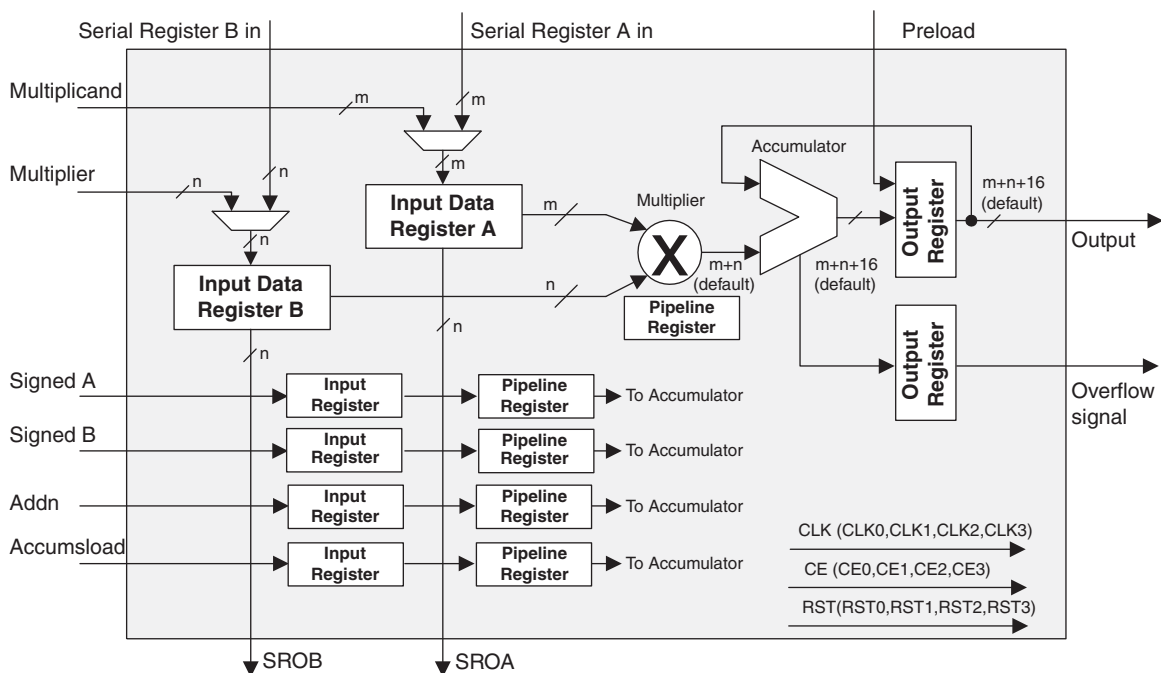
Figure 2-23. MULT sysDSP Element



MAC sysDSP Element

In this case, the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers, but the output register is always enabled. The output register is used to store the accumulated value. The Accumulators in the DSP blocks in the LatticeECP2/M family can be initialized dynamically. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-24 shows the MAC sysDSP element.

Figure 2-24. MAC sysDSP



SERDES and PCS (Physical Coding Sublayer)

LatticeECP2M devices feature up to 16 channels of embedded SERDES arranged in quads at the corners of the devices. Figure 2-39 shows the position of the quad blocks in relation to the PFU array for LatticeECP2M70 and LatticeECP2M100 devices. Table 2-15 shows the location of Quads for all the devices.

Each quad contains four dedicated SERDES (Ch0 to Ch3) for high-speed, full-duplex serial data transfer. Each quad also has a PCS block that interfaces to the SERDES channels and contains digital logic to support an array of popular data protocols. PCS also contains logic to the interface to FPGA core.

Figure 2-39. SERDES Quads (LatticeECP2M70/LatticeECP2M100)

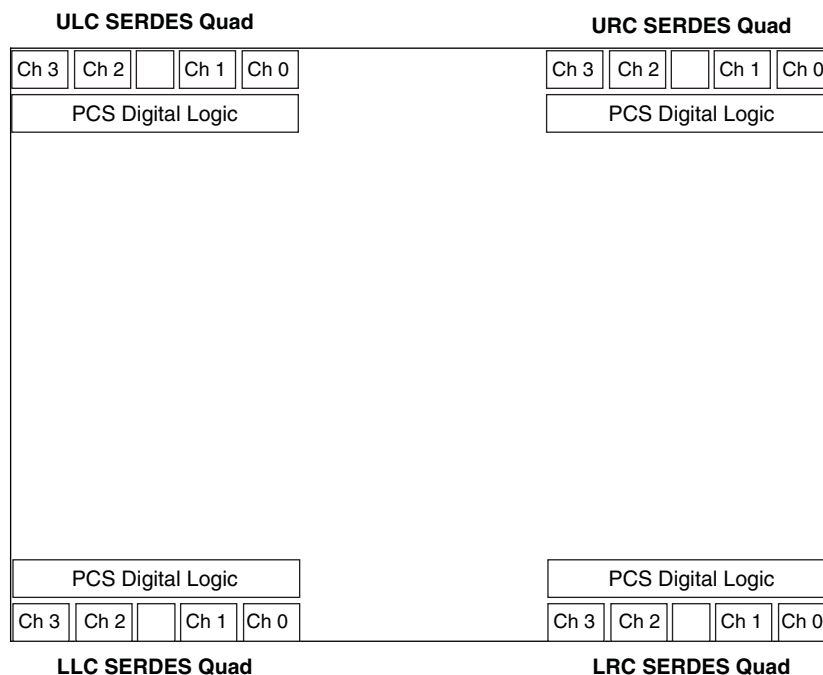


Table 2-15. Available SERDES Quads per LatticeECP2M Devices

Device	URC Quad	ULC Quad	LRC Quad	LLC Quad
ECP2M20	Available	—	—	—
ECP2M35	Available	—	—	—
ECP2M50	Available	—	Available	—
ECP2M70	Available	Available	Available	Available
ECP2M100	Available	Available	Available	Available

SERDES Block

A differential receiver receives the serial encoded data stream, equalizes the signal, extracts the buried clock and de-serializes the data-stream before passing the 8- or 10-bit data to the PCS logic. The transmit channel receives the parallel (8- or 10-bit) encoded data, serializes the data and transmits the serial bit stream through the differential buffers. There is a single transmit clock per quad. Figure 2-40 shows a single channel SERDES and its interface to the PCS logic. Each SERDES receiver channel provides a recovered clock to the PCS block and to the FPGA core logic.

sys/I/O Recommended Operating Conditions

Standard	V _{CCIO}			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 3.3 ²	3.135	3.3	3.465	—	—	—
LVC MOS 2.5 ²	2.375	2.5	2.625	—	—	—
LVC MOS 1.8	1.71	1.8	1.89	—	—	—
LVC MOS 1.5	1.425	1.5	1.575	—	—	—
LVC MOS 1.2 ²	1.14	1.2	1.26	—	—	—
LVTTL ²	3.135	3.3	3.465	—	—	—
PCI	3.135	3.3	3.465	—	—	—
SSTL18 ² Class I, II	1.71	1.8	1.89	0.833	0.9	0.969
SSTL2 ² Class I, II	2.375	2.5	2.625	1.15	1.25	1.35
SSTL3 ² Class I, II	3.135	3.3	3.465	1.3	1.5	1.7
HSTL ² 15 Class I	1.425	1.5	1.575	0.68	0.75	0.9
HSTL ² 18 Class I, II	1.71	1.8	1.89	0.816	0.9	1.08
LVDS ²	2.375	2.5	2.625	—	—	—
MLVDS25 ¹	2.375	2.5	2.625	—	—	—
LVPECL33 ^{1,2}	3.135	3.3	3.465	—	—	—
BLVDS25 ^{1,2}	2.375	2.5	2.625	—	—	—
RSDS ^{1,2}	2.375	2.5	2.625	—	—	—
SSTL18D_I ² , II ²	1.71	1.8	1.89	—	—	—
SSTL25D_I ² , II ²	2.375	2.5	2.625	—	—	—
SSTL33D_I ² , II ²	3.135	3.3	3.465	—	—	—
HSTL15D_I ²	1.425	1.5	1.575	—	—	—
HSTL18D_I ² , II ²	1.71	1.8	1.89	—	—	—

1. Inputs on chip. Outputs are implemented with the addition of external resistors.

2. Input on this standard does not depend on the value of V_{CCIO}.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
		LFE2M100	1.00	—	1.20	—	1.40	—	ns
t _{SU_DELPLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
		LFE2M100	2.00	—	2.20	—	2.40	—	ns
t _{H_DELPLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns

DDR I/O Pin Parameters²

t _{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t _{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t _{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t _{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f _{MAX_DDR}	DDR Clock Frequency ⁶	ECP2/M	95	200	95	166	95	133	MHz

DDR2 I/O Pin Parameters³

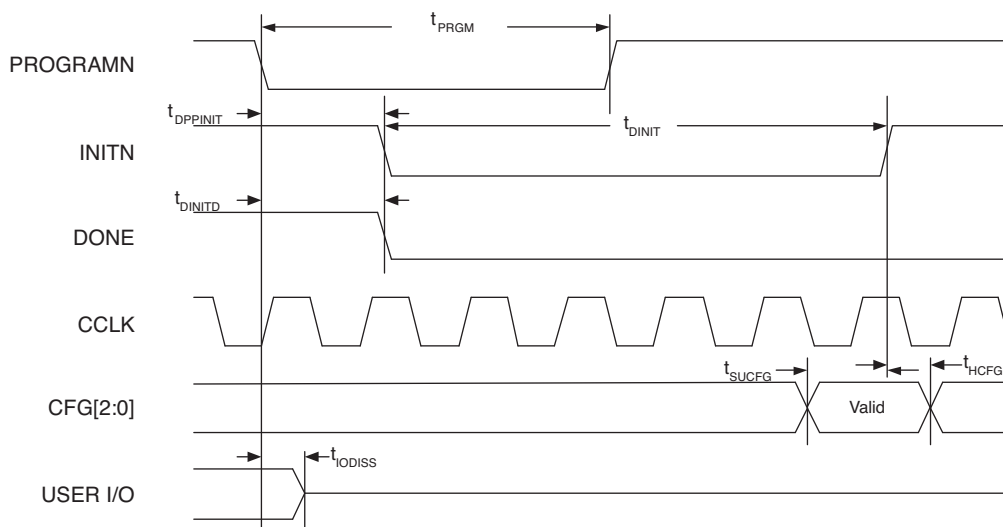
t _{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t _{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

Figure 3-18. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-19. Wake-Up Timing

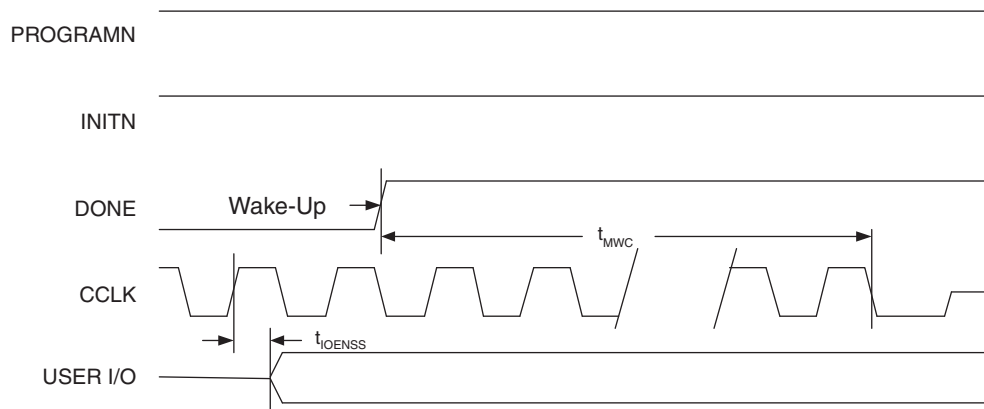
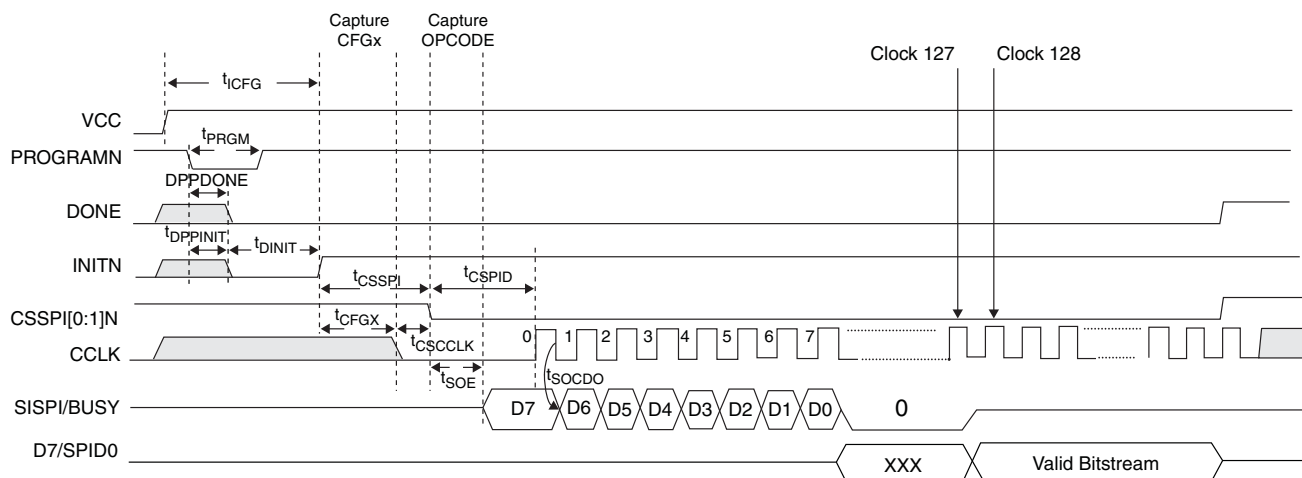


Figure 3-20. SPI/SPI_m Configuration Waveforms



LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		131	193	331	402	331	450
Differential Pair User I/O		62	96	165	200	165	224
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	42	54	60	64	60	68
	Dedicated Pins	3	3	3	3	3	3
VCC		14	7	18	24	16	22
VCCAUX		8	4	16	16	16	16
VCCPLL		0	0	0	0	2	2
VCCIO	Bank0	2	2	4	5	4	5
	Bank1	2	2	4	5	4	5
	Bank2	2	2	4	5	4	5
	Bank3	2	2	4	5	4	5
	Bank4	2	2	4	5	4	5
	Bank5	2	2	4	5	4	5
	Bank6	2	2	4	5	4	5
	Bank7	2	2	4	5	4	5
	Bank8	2	1	2	2	2	2
GND, GND0 to GND7		22	20	60	72	60	72
NC		0	1	8	101	8	102
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	18/9	18/9	50/25	67/33	50/25	67/33
	Bank1	18/9	34/17	46/23	52/26	46/23	52/26
	Bank2	11/5	20/10	34/17	36/18	34/17	48/24
	Bank3	11/5	12/6	22/11	32/16	22/11	42/21
	Bank4	19/9	32/16	46/23	50/25	46/23	54/27
	Bank5	18/9	17/8	46/23	68/34	46/23	68/34
	Bank6	18/8	26/13	40/20	48/24	40/20	58/29
	Bank7	12/6	20/10	33/16	35/17	33/16	47/23
	Bank8	6/2	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	4	5	9	9	9	12
	Bank3 (Right Edge)	3	3	5	8	5	9
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	6	7	10	12	10	13
	Bank7 (Left Edge)	5	5	8	8	8	11
	Bank8 (Right Edge)	0	0	0	0	0	0

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
V _{CC}	LFE2M35: AD13, AD14, AD16, AD17, AD19, AD21, AD22, AD24, AD25, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2M50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	LFE2M50: AH1, AH4, AH5, AH2, AH7, AH12, AH9, AH10, AH13, C13, C10, C9, C12, C7, C2, C5, C4, C1, L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19 LFE2M70/LFE2M100: L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19
V _{CCIO0}	B12, B7, F11, J13, K12	D14, E6, E9, F12, K12, K13
V _{CCIO1}	D18, F16, J14, K15	D17, E22, E25, F19, K18, K19
V _{CCIO2}	G25, L21, M17, M25, N18	F28, J25, K28, M21, M24, N21, N28, P21, R25
V _{CCIO3}	P18, R17, R25, T21, Y25	AA28, AB25, AE28, T25, U21, V21, V28, W21, W24
V _{CCIO4}	AA16, AC18, U15, V14	AA18, AA19, AE19, AF22, AG17, AG25
V _{CCIO5}	AA11, AE12, AE7, U12, V13	AA12, AA13, AE12, AF9, AG14, AG6
V _{CCIO6}	P9, R10, R2, T6, Y2	AA3, AB6, AE3, T6, U10, V10, V3, W10, W7
V _{CCIO7}	G2, L6, M10, M2, N9	F3, J6, K3, M10, M7, N10, N3, P10, R6
V _{CCIO8}	AC24, U17	AA25, AD28
V _{CCJ}	AA7	AG1
V _{CCAUX}	LFE2M35: AE19, J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16 LFE2M50: J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16	LFE2M50: AJ7, B7, AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21 LFE2M70/LFE2M100: AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21
V _{CCPLL}	H7, K6, P7, R8, V18, P20, J17, G19	N13, N18, V13, V18
SERDES Power ³	LFE2M35: C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13 LFE2M50: AD13, AE13, AD16, AF16, AD17, AD18, AD14, AD15, AD19, AE19, AD23, AD24, AD20, AD21, AF22, AD22, AE25, AD25, C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13	LFE2M50: AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18 LFE2M70/LFE2M100: C13, B13, C10, A10, C9, C8, C12, C11, B7, C7, C3, C2, C6, C5, A4, C4, B1, C1, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18, AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, AH1, AJ1, AH4, AK4, AH5, AH6, AH2, AH3, AH7, AJ7, AH11, AH12, AH8, AH9, AK10, AH10, AJ13, AH13

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F15	PR11B	2	RDQ10	C	PR11B	2	RDQ10	C
G11	PR12B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ10	C (LVDS)*
F14	PR11A	2	RDQ10	T	PR11A	2	RDQ10	T
VCCIO	VCCIO2	2			VCCIO2	2		
F12	PR12A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ10	T (LVDS)*
G14	PR10B	2	RDQ10	C (LVDS)*	PR10B	2	RDQ10	C (LVDS)*
G13	PR10A	2	RDQS10	T (LVDS)*	PR10A	2	RDQS10	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
F16	PR8B	2	RDQ10	C (LVDS)*	PR8B	2	RDQ10	C (LVDS)*
F9	PR9B	2	RDQ10	C	PR9B	2	RDQ10	C
E16	PR8A	2	RDQ10	T (LVDS)*	PR8A	2	RDQ10	T (LVDS)*
F10	PR9A	2	RDQ10	T	PR9A	2	RDQ10	T
VCCIO	VCCIO2	2			VCCIO2	2		
D16	PR7B	2	RDQ10	C	PR7B	2	RDQ10	C
D15	PR7A	2	RDQ10	T	PR7A	2	RDQ10	T
C15	PR4B	2		C (LVDS)*	PR4B	2		C (LVDS)*
C16	PR5B	2		C	PR5B	2		C
GND	GNDIO2	-			GNDIO2	-		
D14	PR4A	2		T (LVDS)*	PR4A	2		T (LVDS)*
B16	PR5A	2		T	PR5A	2		T
F13	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
E13	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
F11	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C
E11	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T
GND	GNDIO1	-			GNDIO1	-		
A15	PT27B	1		C	PT54B	1		C
E12	PT26B	1		C	PT53B	1		C
B15	PT27A	1		T	PT54A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D12	PT26A	1		T	PT53A	1		T
B14	PT25B	1		C	PT52B	1		C
C14	PT24B	1		C	PT51B	1		C
A14	PT25A	1		T	PT52A	1		T
D13	PT24A	1		T	PT51A	1		T
C13	PT23B	1		C	PT50B	1		C
GND	GNDIO1	-			GNDIO1	-		
A13	PT22B	1		C	PT49B	1		C
B13	PT23A	1		T	PT50A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A12	PT22A	1		T	PT49A	1		T
B11	PT21B	1		C	PT48B	1		C
D11	PT20B	1		C	PT47B	1		C
A11	PT21A	1		T	PT48A	1		T
C11	PT20A	1		T	PT47A	1		T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO5	-			GNDIO5	-		
W10	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
Y10	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
W11	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
AA10	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AC8	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
AD8	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
AB8	PB23A	5	BDQ24	T	PB32A	5	BDQ33	T
AB10	PB23B	5	BDQ24	C	PB32B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AE6	PB24A	5	BDQS24	T	PB33A	5	BDQS33	T
AF6	PB24B	5	BDQ24	C	PB33B	5	BDQ33	C
AA11	PB25A	5	BDQ24	T	PB34A	5	BDQ33	T
AC9	PB25B	5	BDQ24	C	PB34B	5	BDQ33	C
AB9	PB26A	5	BDQ24	T	PB35A	5	BDQ33	T
AD9	PB26B	5	BDQ24	C	PB35B	5	BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
Y11	PB27A	5	BDQ24	T	PB36A	5	BDQ33	T
AB11	PB27B	5	BDQ24	C	PB36B	5	BDQ33	C
AE7	PB28A	5	BDQ24	T	PB37A	5	BDQ33	T
AF7	PB28B	5	BDQ24	C	PB37B	5	BDQ33	C
GND	GNDIO5	-			GNDIO5	-		
AC10	PB29A	5	BDQ33	T	PB38A	5	BDQ42	T
AD10	PB29B	5	BDQ33	C	PB38B	5	BDQ42	C
AA12	PB30A	5	BDQ33	T	PB39A	5	BDQ42	T
W12	PB30B	5	BDQ33	C	PB39B	5	BDQ42	C
AB12	PB31A	5	BDQ33	T	PB40A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
Y12	PB31B	5	BDQ33	C	PB40B	5	BDQ42	C
AD12	PB32A	5	BDQ33	T	PB41A	5	BDQ42	T
AC12	PB32B	5	BDQ33	C	PB41B	5	BDQ42	C
AC13	PB33A	5	BDQS33	T	PB42A	5	BDQS42	T
GND	GNDIO5	-			GNDIO5	-		
AA13	PB33B	5	BDQ33	C	PB42B	5	BDQ42	C
AD13	PB34A	5	BDQ33	T	PB43A	5	BDQ42	T
AC14	PB34B	5	BDQ33	C	PB43B	5	BDQ42	C
AE8	PB35A	5	BDQ33	T	PB44A	5	BDQ42	T
VCCIO	VCCIO5	5			VCCIO5	5		
AF8	PB35B	5	BDQ33	C	PB44B	5	BDQ42	C
AB15	PB36A	5	BDQ33	T	PB45A	5	BDQ42	T
Y13	PB36B	5	BDQ33	C	PB45B	5	BDQ42	C
AE9	PB37A	5	BDQ33	T	PB46A	5	BDQ42	T
GND	GNDIO5	-			GNDIO5	-		
AF9	PB37B	5	BDQ33	C	PB46B	5	BDQ42	C
W13	PB38A	5	BDQ42	T	PB47A	5	BDQ51	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR43B	2	RDQ41	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
K22	PR43A	2	RDQ41	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
M24	PR42B	2	RDQ41	C	PR55B	2	RDQ54	C
N23	PR42A	2	RDQ41	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR41B	2	RDQ41	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
K25	PR41A	2	RDQS41	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
M20	PR40B	2	RDQ41	C	PR53B	2	RDQ54	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR40A	2	RDQ41	T	PR53A	2	RDQ54	T
L22	PR39B	2	RDQ41	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
M22	PR39A	2	RDQ41	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
K21	PR38B	2	RDQ41	C	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR38A	2	RDQ41	T	PR51A	2	RDQ54	T
K24	PR37B	2	RDQ41	C (LVDS)*	PR50B	2	RDQ54	C (LVDS)*
J24	PR37A	2	RDQ41	T (LVDS)*	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCCPLL	2			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
J25	PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
J23	PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
K23	PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
H26	PR24B	2	RDQ24	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*
H25	PR24A	2	RDQS24***	T (LVDS)*	PR37A	2	RDQS37***	T (LVDS)*
H24	PR23B	2	RDQ24	C	PR36B	2	RDQ37	C
GND	GNDIO2	-			GNDIO2	-		
H23	PR23A	2	RDQ24	T	PR36A	2	RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR19B	2	RDQ16	C	PR32B	2	RDQ29	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR19A	2	RDQ16	T	PR32A	2	RDQ29	T
F26	PR18B	2	RDQ16	C (LVDS)*	PR31B	2	RDQ29	C (LVDS)*
F25	PR18A	2	RDQ16	T (LVDS)*	PR31A	2	RDQ29	T (LVDS)*
K20	PR17B	2	RDQ16	C	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR17A	2	RDQ16	T	PR30A	2	RDQ29	T
E26	PR16B	2	RDQ16	C (LVDS)*	PR29B	2	RDQ29	C (LVDS)*
E25	PR16A	2	RDQS16	T (LVDS)*	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR15B	2	RDQ16	C	PR28B	2	RDQ29	C
H22	PR15A	2	RDQ16	T	PR28A	2	RDQ29	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
W7	PL72B	6	LDQ71	C
W4	PL73A	6	LLM0_GDLLT_IN_A**/LDQ71	T (LVDS)*
W3	PL73B	6	LLM0_GDLLC_IN_A**/LDQ71	C (LVDS)*
W6	PL74A	6	LLM0_GDLLT_FB_A/LDQ71	T
GND	GNDIO6	-		
W8	PL74B	6	LLM0_GDLLC_FB_D/LDQ71	C
Y8	LLM0_PLLCAP	6		
Y1	PL76A	6	LLM0_GPLLT_IN_A**/LDQ80	T (LVDS)*
Y2	PL76B	6	LLM0_GPLLC_IN_A**/LDQ80	C (LVDS)*
Y5	PL77A	6	LLM0_GPLLT_FB_A/LDQ80	T
Y6	PL77B	6	LLM0_GPLLC_FB_A/LDQ80	C
Y4	PL78A	6	LDQ80	T (LVDS)*
VCCIO	VCCIO6	6		
Y3	PL78B	6	LDQ80	C (LVDS)*
AA6	PL79A	6	LDQ80	T
AA8	PL79B	6	LDQ80	C
AA2	PL80A	6	LDQS80	T (LVDS)*
GND	GNDIO6	-		
AA1	PL80B	6	LDQ80	C (LVDS)*
AA7	PL81A	6	LDQ80	T
AA5	PL81B	6	LDQ80	C
VCCIO	VCCIO6	6		
AA4	PL82A	6	LDQ80	T (LVDS)*
AA3	PL82B	6	LDQ80	C (LVDS)*
AB7	PL83A	6	LDQ80	T
AB5	PL83B	6	LDQ80	C
GND	GNDIO6	-		
AB2	PL84A	6	LDQ88	T (LVDS)*
AB1	PL84B	6	LDQ88	C (LVDS)*
AB8	PL85A	6	LDQ88	T
AB6	PL85B	6	LDQ88	C
VCCIO	VCCIO6	6		
AB4	PL86A	6	LDQ88	T (LVDS)*
AB3	PL86B	6	LDQ88	C (LVDS)*
AC7	PL87A	6	LDQ88	T
AC5	PL87B	6	LDQ88	C
GND	GNDIO6	-		
AC2	PL88A	6	LDQS88	T (LVDS)*
AC1	PL88B	6	LDQ88	C (LVDS)*
AC6	PL89A	6	LDQ88	T
VCCIO	VCCIO6	6		
AD6	PL89B	6	LDQ88	C
AD1	PL90A	6	LDQ88	T (LVDS)*

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AB27	PR97A	3	RDQ99	T (LVDS)*
VCCIO	VCCIO3	3		
Y24	PR96B	3	RDQ99	C
Y25	PR96A	3	RDQ99	T
AA29	PR95B	3	RDQ99	C (LVDS)*
Y28	PR95A	3	RDQ99	T (LVDS)*
Y30	PR93B	3	RDQ90	C
Y29	PR93A	3	RDQ90	T
GNDIO	GNDIO3	-		
VCCIO	VCCIO3	3		
W22	PR83B	3	RDQ81	C (LVDS)*
V22	PR83A	3	RDQ81	T (LVDS)*
Y27	PR82B	3	RDQ81	C
VCCIO	VCCIO3	3		
Y26	PR82A	3	RDQ81	T
W30	PR81B	3	RDQ81	C (LVDS)*
W29	PR81A	3	RDQS81	T (LVDS)*
GNDIO	GNDIO3	-		
W25	PR80B	3	RDQ81	C
W26	PR80A	3	RDQ81	T
U29	PR79B	3	RDQ81	C (LVDS)*
V29	PR79A	3	RDQ81	T (LVDS)*
VCCIO	VCCIO3	3		
V30	PR78B	3	RDQ81	C
U30	PR78A	3	RDQ81	T
W27	PR77B	3	RDQ81	C (LVDS)*
W28	PR77A	3	RDQ81	T (LVDS)*
V24	PR75B	3	RDQ72	C
V25	PR75A	3	RDQ72	T
GNDIO	GNDIO3	-		
U28	PR74B	3	RDQ72	C (LVDS)*
U27	PR74A	3	RDQ72	T (LVDS)*
U23	PR73B	3	RDQ72	C
V23	PR73A	3	RDQ72	T
VCCIO	VCCIO3	3		
V26	PR72B	3	RDQ72	C (LVDS)*
U26	PR72A	3	RDQS72	T (LVDS)*
U25	PR71B	3	RDQ72	C
GNDIO	GNDIO3	-		
U24	PR71A	3	RDQ72	T
T30	PR70B	3	RDQ72	C (LVDS)*
R30	PR70A	3	RDQ72	T (LVDS)*
T23	PR69B	3	RDQ72	C

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H33	PR14B	2	RDQ15	C	PR14B	2	RDQ15	C
GNDIO	GNDIO2	-			GNDIO2	-		
H34	PR14A	2	RDQ15	T	PR14A	2	RDQ15	T
J30	PR13B	2	RDQ15	C (LVDS)*	PR13B	2	RDQ15	C (LVDS)*
J29	PR13A	2	RDQ15	T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
J27	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*
J28	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
H31	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
H32	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
H30	XRES	1			XRES	1		
B33	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
C33	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B34	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
C32	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
B32	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A33	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
C34	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
A32	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
B31	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
A31	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
D32	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A30	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
B30	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
C31	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
D31	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
C30	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
E29	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E30	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D30	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
D29	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
C29	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
D27	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
C28	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
B29	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A29	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
E28	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
A28	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
B28	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
A27	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
D26	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A26	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
B27	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
C27	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B26	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
C26	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
D28	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AG23	VCCIO4	4			VCCIO4	4		
AK21	VCCIO4	4			VCCIO4	4		
AM19	VCCIO4	4			VCCIO4	4		
AM23	VCCIO4	4			VCCIO4	4		
AC14	VCCIO5	5			VCCIO5	5		
AC15	VCCIO5	5			VCCIO5	5		
AG12	VCCIO5	5			VCCIO5	5		
AG16	VCCIO5	5			VCCIO5	5		
AK14	VCCIO5	5			VCCIO5	5		
AM12	VCCIO5	5			VCCIO5	5		
AM16	VCCIO5	5			VCCIO5	5		
AA12	VCCIO6	6			VCCIO6	6		
AB3	VCCIO6	6			VCCIO6	6		
AB8	VCCIO6	6			VCCIO6	6		
AE3	VCCIO6	6			VCCIO6	6		
AE7	VCCIO6	6			VCCIO6	6		
AH3	VCCIO6	6			VCCIO6	6		
W3	VCCIO6	6			VCCIO6	6		
W8	VCCIO6	6			VCCIO6	6		
Y12	VCCIO6	6			VCCIO6	6		
G3	VCCIO7	7			VCCIO7	7		
K3	VCCIO7	7			VCCIO7	7		
K7	VCCIO7	7			VCCIO7	7		
N3	VCCIO7	7			VCCIO7	7		
N8	VCCIO7	7			VCCIO7	7		
P12	VCCIO7	7			VCCIO7	7		
R12	VCCIO7	7			VCCIO7	7		
T3	VCCIO7	7			VCCIO7	7		
T8	VCCIO7	7			VCCIO7	7		
AD28	VCCIO8	8			VCCIO8	8		
AG32	VCCIO8	8			VCCIO8	8		
AB12	VCCAUX	-			VCCAUX	-		
AB13	VCCAUX	-			VCCAUX	-		
AB22	VCCAUX	-			VCCAUX	-		
AB23	VCCAUX	-			VCCAUX	-		
AC13	VCCAUX	-			VCCAUX	-		
AC22	VCCAUX	-			VCCAUX	-		
M13	VCCAUX	-			VCCAUX	-		
M22	VCCAUX	-			VCCAUX	-		
N12	VCCAUX	-			VCCAUX	-		
N13	VCCAUX	-			VCCAUX	-		
N22	VCCAUX	-			VCCAUX	-		
N23	VCCAUX	-			VCCAUX	-		
A1	GND	-			GND	-		
A10	GND	-			GND	-		
A13	GND	-			GND	-		
A22	GND	-			GND	-		
A25	GND	-			GND	-		
A34	GND	-			GND	-		



LatticeECP2/M Family Data Sheet

Revision History

September 2013

Data Sheet DS1006

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
August 2006	01.1	Introduction	
			Updated Table 1-1 "LatticeECP2 Family Selection Guide".
		Architecture	Updated Figure 2-2 "PFU Diagram".
			Updated Figure 2-13 "Secondary Clock Regions ECP2-50".
			Updated Figure 2-25 "PIC Diagram".
			Updated Figure 2-26 "Input Register Block for Left, Right and Bottom Edges".
			Updated Figure 2-28 "Output Register Block for Left, Right and Bottom Edges".
			Updated Figure 2-30 "DQS Input Routing for Left and Right Edges".
			Updated Figure 2-32 "Edge Clock, DLL Calibration and DQS Local Bus Distribution".
			Table 2-15 Selectable Master Clock (CCLK) Frequencies - Removed frequencies 15, 20, 21, 22, 23, 30, 34, 41, 45, 51, 55, 60.
			Replaced "CLKINDEL" with "CLKO".
			Updated SED section.
			Qualified device migration capability when using DQS banks for DDR interfaces.
		DC and Switching Characteristics	Added VCCPLL to the Recommended Operating Conditions table.
			Removed note 5 from "Hot Specifications" section.
			Added notes 7 and 8 to "Initialization Supply" Current table.
			Change note 6 - "...down to 95MHz" to "...down to 95MHz for DDR and 133MHz for DDR2" .
			New "Typical Building Block Function Performance" numbers.
			New External Switching Characteristics numbers.
			New Internal Switching Characteristics numbers.
			New Family Timing Adders numbers.
			Updated Timings for GPLLs, SPLLs and DLLs.
			Added sysCONFIG waveforms.
			Remove HSTL15D_II from sysIO Recommended Operating Conditions table.
			Updated Supply and Initialization Currents for ECP2-50.
		Pinout Information	Added VCCPLL to the Signal Descriptions table.
			Updated Logic Signal Connections tables to include 484-fpBGA for the ECP2-50.
			Added Logic Signal Connections tables for ECP2-12 devices.
			Updated Pin Information Summary table to include ECP2-12.
			Updated Power Supply and NC Connections table to include ECP2-12.
			Added note 2 to DDR Strobe (DQS) Pin table.
			Added Information on: PCI, DDR & SPI4.2 Capabilities of the device-Package combination.

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Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVCMOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
April 2008	03.1	Pinout Information	Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
June 2008	03.2	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
		Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
August 2008	03.3	DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
		Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPI _m Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t _{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.